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October 1995 Revised May 2003

NC7S32

TinyLogic® HS 2-Input OR Gate

General Description

The NC7S32 is a single 2-Input high performance CMOS OR Gate. Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation over a broad V_{CC} range. ESD protection diodes inherently guard both inputs and output with respect to the V_{CC} and GND rails. Three stages of gain between inputs and outputs assures high noise immunity and reduced sensitivity to input edge rate.

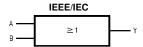
Features

- Space saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ leadless package
- High Speed; t_{PD} 3.5 ns typ
- \blacksquare Low Quiescent Power; $I_{CC} < 1~\mu\text{A}$
- \blacksquare Balanced Output Drive; 2 mA I $_{\rm OL}$, –2 mA I $_{\rm OH}$
- Broad V_{CC} Operating Range: 2V–6V
- Balanced Propagation Delays
- Specified for 3V Operation

Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As	
NC7S32M5X	MA05B	7S32	5-Lead SOT23, JEDEC MO-178, 1.6mm	3k Units on Tape and Reel	
NC7S32P5X	MAA05A	S32	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel	
NC7S32L6X	MAC06A	TT	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel	

Logic Symbol



Pin Descriptions

Pin Names	Description
A, B	Inputs
Y	Output
NC	No Connect

Function Table

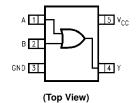
$$Y = A + B$$

Inp	Output			
Α	A B			
Ĺ	Ĺ	Ĺ		
L	Н	Н		
Н	L	Н		
Н	Н	Н		

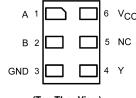
H = HIGH Logic Level L = LOW Logic Level

Connection Diagrams

Pin Assignments for SC70 and SOT23



Pad Assignments for MicroPak



(Top Thru View)

 $\label{eq:total_cond} \mbox{TinyLogic@ is a registered trademark of Fairchild Semiconductor Corporation.} \\ \mbox{MicroPak}^{\tiny TM} \mbox{ is a trademark of Fairchild Semiconductor Corporation.} \\$

Absolute Maximum Ratings(Note 1)

Supply Voltage (V _{CC})	-0.5V to +7.0V
DC Input Diode Current (I _{IK})	
$@V_{IN} \le -0.5V$	−20 mA
$@V_{IN} \ge V_{CC} + 0.5V$	+20 mA
DC Input Voltage (V _{IN})	$-0.5V$ to $V_{CC} + 0.5V$
DC Output Diode Current (I _{OK})	
$@V_{OUT} < -0.5V$	−20 mA

 $@V_{OUT} > V_{CC} + 0.5V$ +20 mA DC Output Voltage (V_{OUT}) -0.5V to $V_{CC} + 0.5V$

DC Output Source or Sink

Current (I_{OUT})

DC V_{CC} or Ground Current per

Output Pin (I_{CC} or I_{GND}) ±25 mA Storage Temperature (T_{STG}) -65°C to +150°C

Junction Temperature (T_J) Lead Temperature (T_L)

(Soldering, 10 seconds)

Power Dissipation (P_D) @ +85°C

SOT23-5

200 mW SC70-5 150 mW

Recommended Operating Conditions (Note 2)

Supply Voltage (V_{CC}) 2.0V to 6.0V Input Voltage (V_{IN}) 0V to V_{CC} Output Voltage (V_{OUT}) 0V to V_{CC} -40°C to +85°C Operating Temperature (T_A)

Input Rise and Fall Time $(t_r,\,t_f)$

V_{CC} @ 2.0V 0 to 1000 ns V_{CC} @ 3.0V 0 to 750 ns V_{CC} @ 4.5V 0 to 500 ns V_{CC} @ 6.0V 0 to 400 ns

Thermal Resistance (θ_{JA})

±12.5 mA

150°C

260°C

SOT23-5 300°C/W 425°C/W SC70-5

Note 1: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation of circuits outside the databook specifications.

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

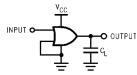
Symbol	Parameter	V _{CC}		$T_A = +25^{\circ}C$		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Condition
Symbol		(V)	Min	Тур	Max	Min	Max	Units	Condition
V _{IH}	HIGH Level Input Voltage	2.0	1.50			1.50		V	
		3.0-6.0	0.7V _{CC}			0.7V _{CC}		V V	
V _{IL}	LOW Level Input Voltage	2.0			0.50		0.50	V	
		3.0-6.0			$0.3~V_{\rm CC}$		0.3 V _{CC}	· •	
V _{OH}	HIGH Level Output Voltage	2.0	1.90	2.0		1.90			
		3.0	2.90	3.0		2.90		v	$I_{OH} = -20 \ \mu A$
		4.5	4.40	4.5		4.40		· ·	$V_{IN} = V_{IH}$
		6.0	5.90	6.0		5.90			
									$V_{IN} = V_{IH}$
		3.0	2.68	2.85		2.63		v	$I_{OH} = -1.3 \text{ mA}$
		4.5	4.18	4.35		4.13		V V	$I_{OH} = -2 \text{ mA}$
		6.0	5.68	5.85		5.63			$I_{OH} = -2.6 \text{ mA}$
V_{OL}	LOW Level Output Voltage	2.0		0.0	0.10		0.10		
		3.0		0.0	0.10		0.10	v	$I_{OL} = 20 \mu A$
	İ	4.5		0.0	0.10		0.10	· •	$V_{IN} = V_{IL}$
		6.0		0.0	0.10		0.10		
									$V_{IN} = V_{IL}$
		3.0		0.1	0.26		0.33	v	$I_{OL} = 1.3 \text{ mA}$
		4.5		0.1	0.26		0.33	· ·	$I_{OL} = 2 \text{ mA}$
		6.0		0.1	0.26		0.33		$I_{OL} = 2.6 \text{ mA}$
I _{IN}	Input Leakage Current	6.0			±0.1		±1.0	μΑ	$V_{IN} = V_{CC}$, GND
I _{CC}	Quiescent Supply Current	6.0			1.0		10.0	μΑ	$V_{IN} = V_{CC}$, GND

AC Electrical Characteristics

Symbol	Parameter	v _{cc}	T _A = +25°C			$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	Figure
		(V)	Min	Тур	Max	Min	Max	Units		Number
t _{PLH} ,	Propagation Delay	5.0		3.5	15			ns	$C_{L} = 15 pF$	
t _{PHL}	PHL			20	100		125			1
		3.0		12	27		35	ns	C _L = 50 pF	Figures 1, 3
		4.5		8	20		25			
		6.0		7	17		21			
t _{TLH} ,	Output Transition Time	5.0		3.0	10			ns	$C_{L} = 15 pF$	
t _{THL}		2.0		25	125		155			l
		3.0		16	35		45		C 50 = F	Figures 1, 3
		4.5		11	25		31	ns	$C_L = 50 pF$	
		6.0		9	21		26			
C _{IN}	Input Capacitance	Open		2	10		10	pF		
C _{PD}	Power Dissipation Capacitance	5.0		6				pF	(Note 3)	Figure 2

Note 3: C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See *Figure 2*) C_{PD} is related to I_{CCD} dynamic operating current by the expression: I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC}static).

AC Loading and Waveforms



C_L includes load and stray capacitance

Input PRR = 1.0 MHz, t_{w} = 500 ns

FIGURE 1. AC Test Circuit



Input = AC Waveforms;

PRR = variable; Duty Cycle = 50%

FIGURE 2. $I_{\rm CCD}$ Test Circuit

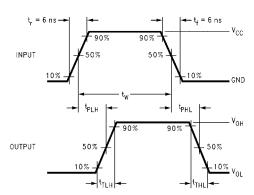


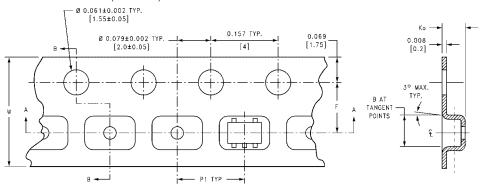
FIGURE 3. AC Waveforms

Tape and Reel Specification

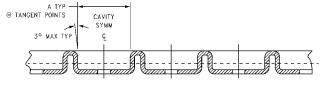
TAPE FORMAT for SC70 and SOT23

TAPET OF IMATED SO 70 and SO 125								
Package	Tape	Number	Cavity	Cover Tape				
Designator	Section	Cavities	Status	Status				
	Leader (Start End)	125 (typ)	Empty	Sealed				
M5X, P5X	Carrier	3000	Filled	Sealed				
	Trailer (Hub End)	75 (typ)	Empty	Sealed				

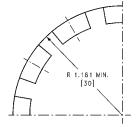
TAPE DIMENSIONS inches (millimeters)



DIRECTION OF FEED _____



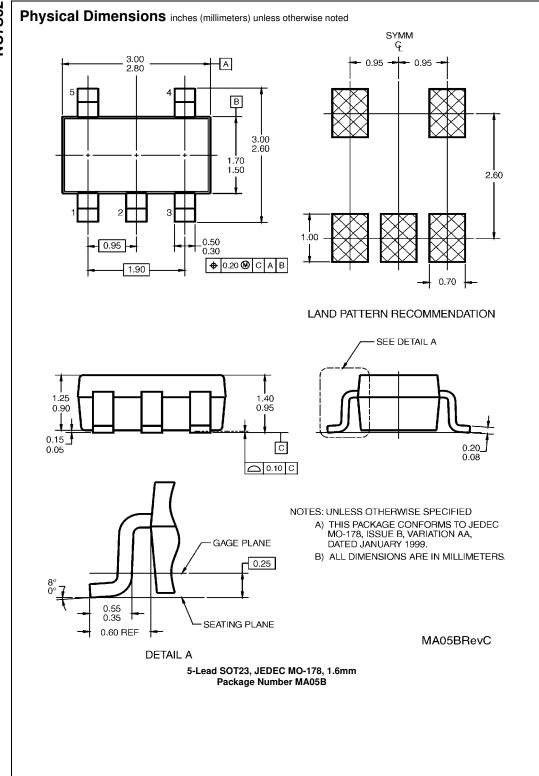
SECTION A-A

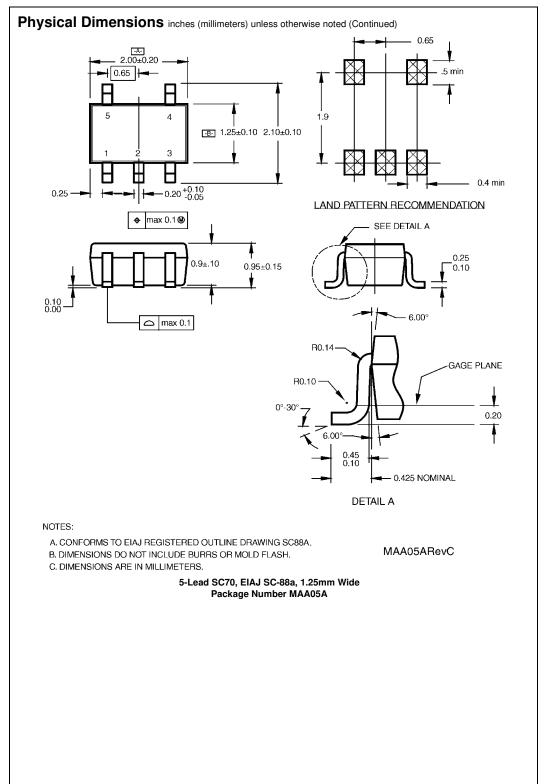


BEND RADIUS NOT TO SCALE

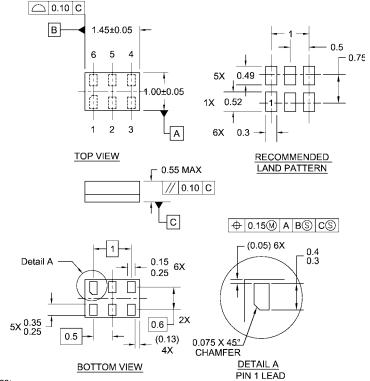
Package	Tape Size	DIM A	DIM B	DIM F	DIM K _o	DIM P1	DIM W
SC70-5	8 mm	0.093	0.096	0.138 ±0.004	0.053 ±0.004	0.157	0.315 ±0.004
		(2.35)	(2.45)	(3.5 ±0.10)	(1.35 ± 0.10)	(4)	(8 ±0.1)
SOT23-5	8 mm	0.130	0.130	0.138 ±0.002	0.055 ±0.004	0.157	0.315 ±0.012
		(3.3)	(3.3)	(3.5 ±0.05)	(1.4 ±0.11)	(4)	(8 ±0.3)

Tape and Reel Specification (Continued) TAPE FORMAT for MicroPak Package Tape Number Cavity Cover Tape Designator Section Cavities Status Status Leader (Start End) Empty 125 (typ) Sealed L6X Carrier 5000 Filled Sealed Trailer (Hub End) 75 (typ) **Empty** Sealed 2.00-1.75±0.10 В 8.00 ^{+0.30} -0.10 3.50±0.05 1.15±0.05 **-** → В◄ -ø 0.50 ±0.05 SECTION B-B DIRECTION OF FEED SCALE:10X 0.254±0.020 Γ ^{0.70±0.05} SECTION A-A SCALE:10X **REEL DIMENSIONS** inches (millimeters) TAPE SLOT DETAIL X DETAIL X SCALE: 3X W1 W2 W3 Tape В С N D Size 0.331 +0.059/-0.000 7.0 0.795 0.567 W1 +0.078/-0.039 0.059 0.512 2.165 8 mm (177.8)(1.50)(13.00)(20.20)(55.00)(8.40 +1.50/-0.00) (14.40)(W1 +2.00/-1.00)





Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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